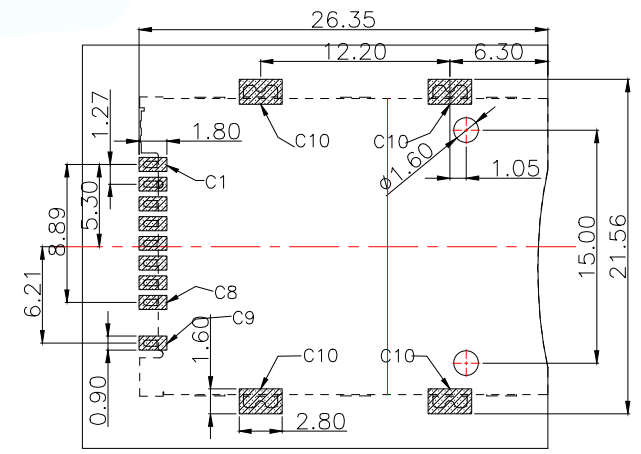
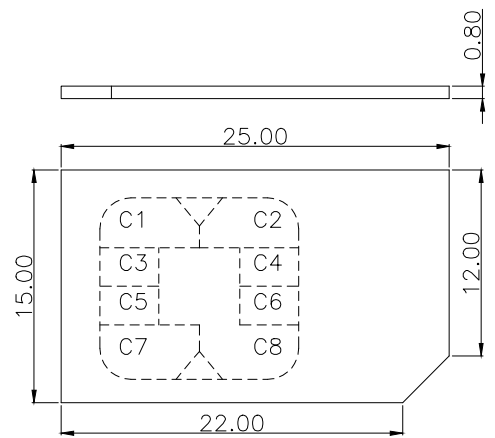
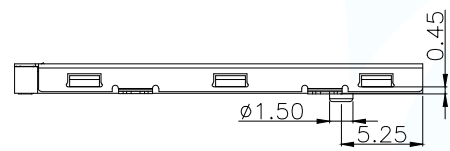
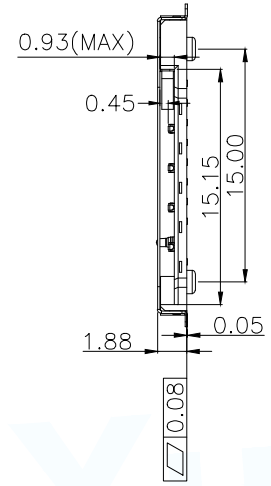


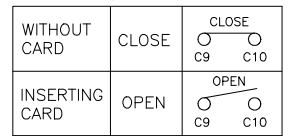
(1.00)LOCATION OF CARD PUSHED  
 (2.00)LOCATION OF CARD LOCK  
 (6.00)LOCATION OF CARD EJECTED



PAD AREA  
 KEEP OUT AREA

RECOMMENDED PCB LAYOUT  
 GENERAL TOLERANCE ±0.05

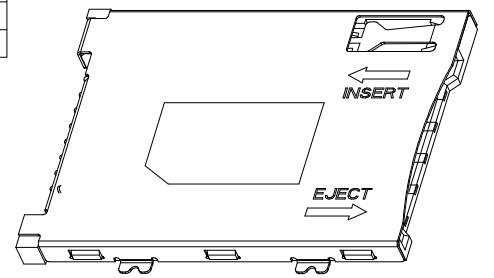
Circuit Diagram for Detect Switch



NOTES:

- MATERIAL:  
 HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V\_0,COLOR:BLACK.  
 CONTACT: COPPER ALLOYS.  
 COVER: COPPER ALLOYS OR STEEL.
- PLATING:  
 UNDERPLATE: NICKEL.  
 CONTACT AREA: GOLD OVER NICKEL.  
 SOLDER AREA: TIN OVER NICKEL.
- MULTIMEDIA CARD COMPATIBLE

MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	GND OF SIM
C3	RST OF SIM
C4	VPP OF SIM
C5	CLK OF SIM
C6	I/O OF SIM
C7	DATO OF SIM
C8	MCMD OF SIM
C9	CARD DETECT SWITCH
C10	GND OF SIM



MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE:MINI SIM CARD PUSH PUSH 8+1P SMT有柱 H1.9	
DECIMALS:	ANGLES:	PAR	SIM-115C
X.X:±0.35	X.X':±3°	DWN	
X.XX:±0.25	X.XX':±2°	CHKD	
X.XXX:±0.15		APVD	
CUSTOMER COPY		SCALE:1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A

